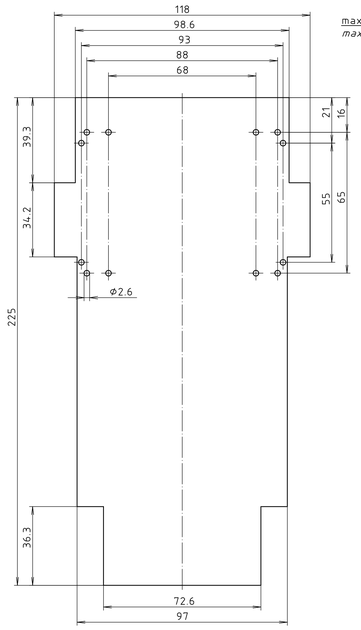
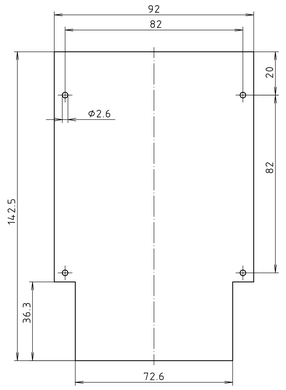


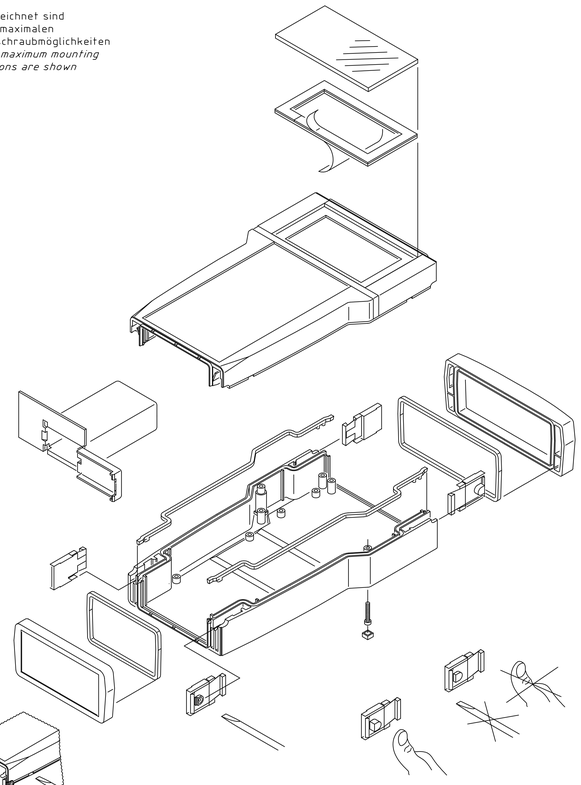
max. Platine für Montage im OT/
max. PCB for mounting in Lid

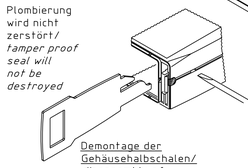
Ebene 1 ohne Batterie (klemmbar)/
level 1 without Battery (clamped)



Ebene 2 ohne Batterie
level 2 without Battery

Anmerkung: Gezeichnet sind die maximalen Anschraubmöglichkeiten
Note: the maximum mounting options are shown

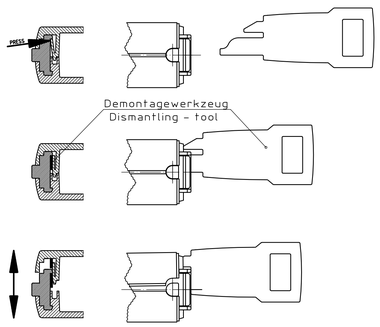


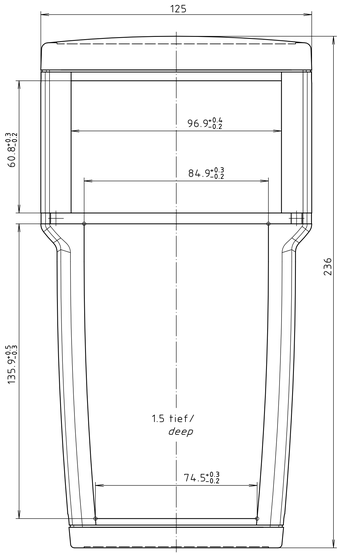


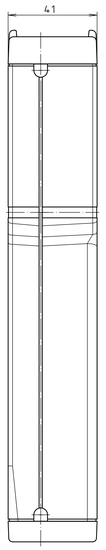
Plombierung wird nicht zerstört/
tamper proof seal will not be destroyed

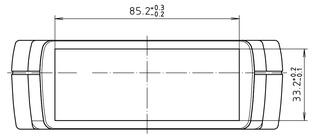
Plombierung wird zerstört/
tamper proof seal will be destroyed

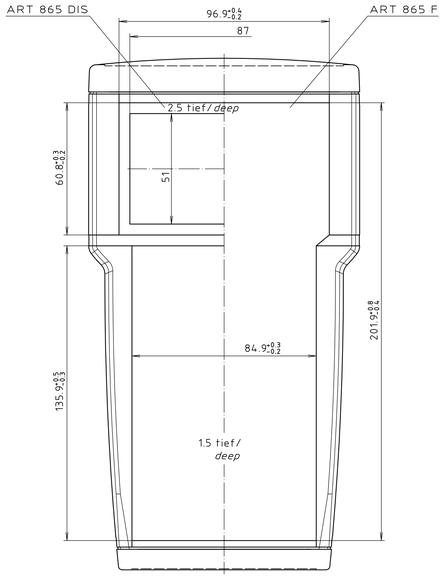
Demontage der Gehäusehalbschalen/
disassembly of half shells

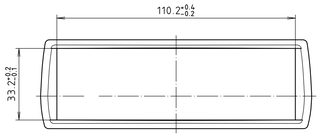




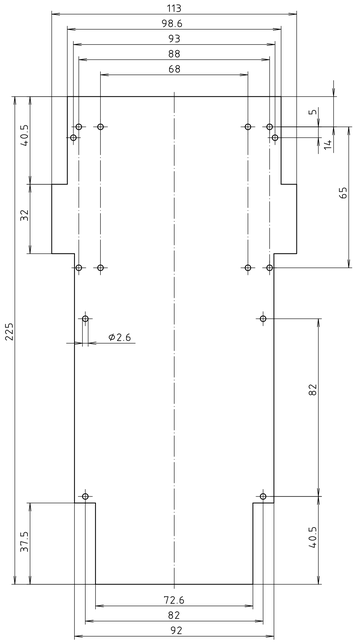






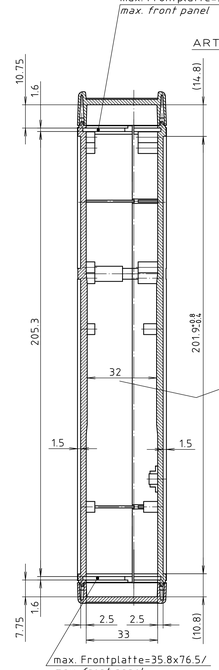


max. Platine für Montage im UT/
max. PCB for mounting in Base

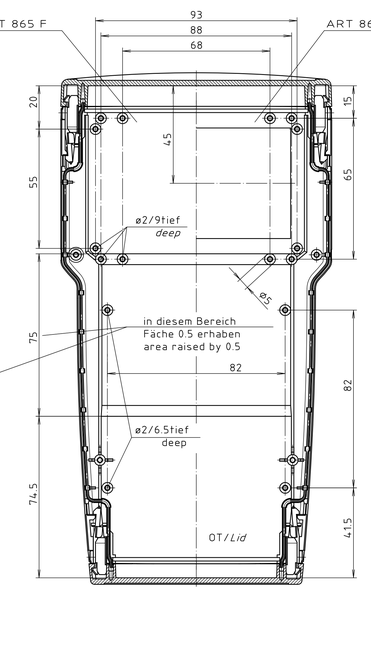


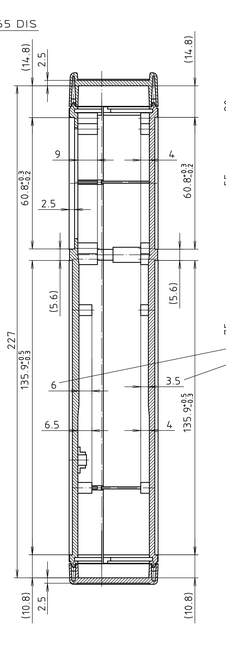
ohne Batterie/
without Battery

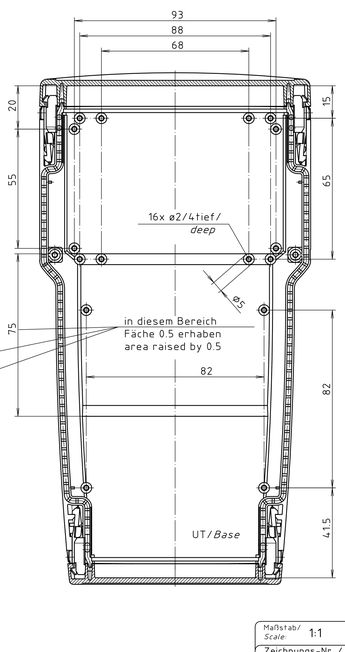
max. Frontplatte=35.8x102.5
max. front panel

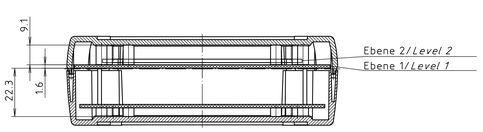


max. Frontplatte=35.8x76.5/
max. front panel

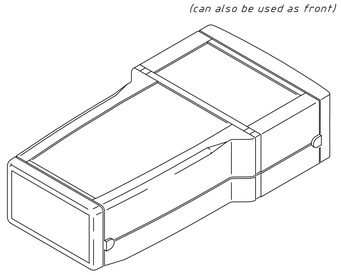




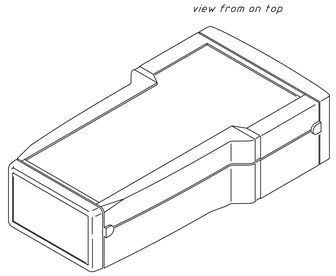




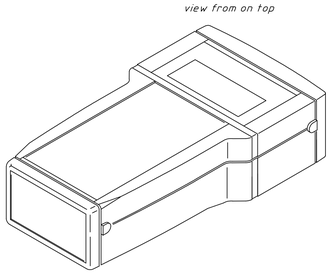
ART 865 F/DIS
Ansicht von unten
(auch als Frontseite verwendbar)/
view from underneath (can also be used as front)



ART 865 F
Ansicht von oben
view from on top



ART 865 DIS
Ansicht von oben
view from on top



Maßstab/ *Scale*: 1:1

Zeichnungs-Nr. / *Drawing-No.*:
10K 5300.170.03

Artikel / *Article*:
ART 865 F
ART 865 DIS
Katalogzeichnung/ *Catalogue drawing*

3779 3628	23.01.2006 20.08.2002
A.Nr./ *Art.-No.*:	Datum/ *Date*:

BOPLA
A Phoenix Mecano Company

DISK: 2 801 639
Datum/ *Date*: 19.05.98 KH

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